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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

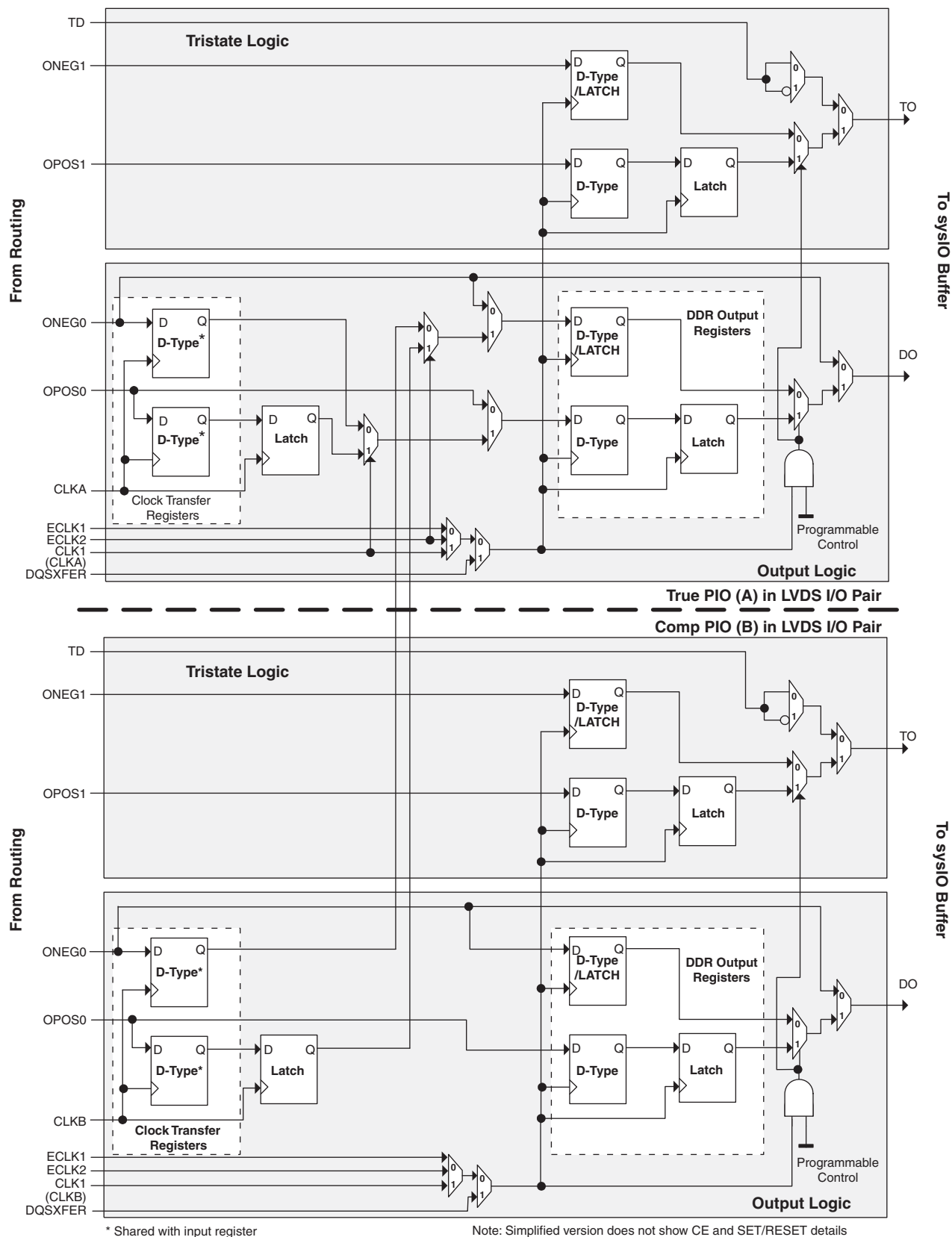
Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Active
Number of LABs/CLBs	6000
Number of Logic Elements/Cells	48000
Total RAM Bits	4246528
Number of I/O	270
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2m50se-7fn484c

Figure 2-31. Output and Tristate Block for Left, Right and Bottom Edges



Symbol	Parameter	Min.	Max.	Units
V_{CCP}^6	PLL and Reference Clock Buffer Power	1.14	1.26	V

1. If V_{CCIO} or V_{CCJ} is set to 1.2V, they must be connected to the same power supply as V_{CC} . If V_{CCIO} or V_{CCJ} is set to 3.3V, they must be connected to the same power supply as V_{CCAUX} . V_{CCPLL} must be connected to the same power supply as V_{CC} through careful filtering and decoupling.
2. See recommended voltages by I/O standard in subsequent table.
3. V_{CCAUX} ramp rate must not exceed 30mV/ μ s during power-up when transitioning between 0V and 3.3V.
4. For proper power-up configuration, users must ensure that the configuration control signals such as the CFGx, INITN, PROGRAMN and DONE pins are driven to the proper logic levels when the device powers up. The device power-up is triggered by the last of V_{CC} , V_{CCAUX} or V_{CCIO8} supplies that reaches its minimum valid levels. Alternatively, if the configuration control signals are pulled up by V_{CCIO8} , the V_{CCIO8} (configuration I/O bank) voltage must be powered up prior to or at the same time as the last of V_{CC} or V_{CCAUX} reaches its minimum levels.
5. For power-up, V_{CC} must reach its valid minimum value before powering up V_{CCAUX} (LatticeECP2/M "S" version devices only).
6. V_{CCRX} , V_{CCTX} and V_{CCP} must be tied together in each quad and all quads need to be powered up.
7. For more power supply design recommendations, refer to TN1114 [Electrical Recommendations for Lattice SERDES](#).

Hot Socketing Specifications^{1, 2, 3, 4}

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
I_{DK}	Input or I/O leakage current	$0 \leq V_{IN} \leq V_{IH} \text{ (MAX.)}$	—	—	+/-1000	μ A
I_{HDIN}^5	SERDES average input current when device is powered down and inputs are driven		—	—	4	mA

1. V_{CC} , V_{CCAUX} and V_{CCIO} should rise/fall monotonically. V_{CC} and V_{CCPLL} must be connected to the same power supply (applies to ECP2-6, ECP2-12 and ECP2-20 only).
2. $0 \leq V_{CC} \leq V_{CC} \text{ (MAX.)}$, $0 \leq V_{CCIO} \leq V_{CCIO} \text{ (MAX.)}$ or $0 \leq V_{CCAUX} \leq V_{CCAUX} \text{ (MAX.)}$.
3. I_{DK} is additive to I_{PU} , I_{PW} or I_{BH} .
4. LVCMOS and LVTTL only.
5. Assumes that the device is powered down with all supplies grounded, both P and N inputs driven by a CML driver with maximum allowed V_{CCIB} of 1.575V, 8b10b data and internal AC coupling.

ESD Performance

Please refer to [LatticeECP2/M Product Family Qualification Summary](#) for complete qualification data, including ESD performance.

LatticeECP2/M External Switching Characteristics⁹ (Continued)

Over Recommended Operating Conditions

Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t_{DQVBS}	Data Valid Before DQS (DDR Write)	ECP2/M	0.250	—	0.250	—	0.250	—	UI
t_{DQVAS}	Data Valid After DQS (DDR Write)	ECP2/M	0.250	—	0.250	—	0.250	—	UI
f_{MAX_DDR2}	DDR Clock Frequency	ECP2/M	133	266	133	200	133	166	MHz
SPI4.2 I/O Pin Parameters Static Alignment^{4, 8, 11}									
	Maximum Data Rate	ECP2-20	—	750	—	622	—	622	Mbps
		ECP2-35	—	750	—	622	—	622	Mbps
		ECP2-50	—	750	—	622	—	622	Mbps
		ECP2-70	—	750	—	622	—	622	Mbps
		ECP2M20	—	622	—	622	—	622	Mbps
		ECP2M35	—	622	—	622	—	622	Mbps
		ECP2M50	—	622	—	622	—	622	Mbps
		ECP2M70	—	622	—	622	—	622	Mbps
		ECP2M100	—	622	—	622	—	622	Mbps
$t_{DVACLKSPI}$	Data Valid After CLK (Receive)	ECP2-20	—	0.25	—	0.25	—	0.25	UI
		ECP2-35	—	0.25	—	0.25	—	0.25	UI
		ECP2-50	—	0.25	—	0.25	—	0.25	UI
		ECP2-70	—	0.25	—	0.25	—	0.25	UI
		ECP2M20	—	0.21	—	0.21	—	0.21	UI
		ECP2M35	—	0.21	—	0.21	—	0.21	UI
		ECP2M50	—	0.21	—	0.21	—	0.21	UI
		ECP2M70	—	0.21	—	0.21	—	0.21	UI
		ECP2M100	—	0.21	—	0.21	—	0.21	UI
$t_{DVECLKSPI}$	Data Hold After CLK (Receive)	ECP2-20	0.75	—	0.75	—	0.75	—	UI
		ECP2-35	0.75	—	0.75	—	0.75	—	UI
		ECP2-50	0.75	—	0.75	—	0.75	—	UI
		ECP2-70	0.75	—	0.75	—	0.75	—	UI
		ECP2M20	0.79	—	0.79	—	0.79	—	UI
		ECP2M35	0.79	—	0.79	—	0.79	—	UI
		ECP2M50	0.79	—	0.79	—	0.79	—	UI
		ECP2M70	0.79	—	0.79	—	0.79	—	UI
		ECP2M100	0.79	—	0.79	—	0.79	—	UI
t_{DIASPI}	Data Invalid After Clock (Transmit)	ECP2-20	—	280	—	280	—	280	ps
		ECP2-35	—	280	—	280	—	280	ps
		ECP2-50	—	280	—	280	—	280	ps
		ECP2-70	—	280	—	280	—	280	ps
		ECP2M20	—	230	—	230	—	230	ps
		ECP2M35	—	230	—	230	—	230	ps
		ECP2M50	—	230	—	230	—	230	ps
		ECP2M70	—	230	—	230	—	230	ps
		ECP2M100	—	230	—	230	—	230	ps

SERDES High-Speed Data Transmitter (LatticeECP2M Family Only)^{1, 2}

Table 3-7. Serial Output Timing and Levels

Symbol	Description	Frequency	Min.	Typ.	Max.	Units
V _{TX-DIFF-P-P-1}	Differential swing (1V setting) ^{1, 2}	0.25 to 3.125 Gbps	0.79	0.99	1.19	V, p-p
V _{TX-DIFF-P-P-1.25}	Differential swing (1.25V setting) ^{1, 2}	0.25 to 3.125 Gbps	1.00	1.25	1.50	V, p-p
V _{TX-DIFF-P-P-1.3}	Differential swing (1.3V setting) ^{1, 2}	0.25 to 3.125 Gbps	1.04	1.30	1.56	V, p-p
V _{TX-DIFF-P-P-1.35}	Differential swing (1.35V setting) ^{1, 2}	0.25 to 3.125 Gbps	1.08	1.35	1.62	V, p-p
V _{OCM}	Output common mode voltage	—	V _{CCOB} - 0.75	V _{CCOB} - 0.60	V _{CCOB} - 0.45	V
T _{TX-R}	Rise time (20% to 80%)	—	—	70	—	ps
T _{TX-F}	Fall time (80% to 20%)	—	—	70	—	ps
Z _{TX-OI-SE}	Output impedance 50/75/HiZ K Ohms (single-ended)	—	—	50/70 HiZ	—	Ohms
R _{TX-RL}	Return loss (with package)	—	—	9	—	dB

1. All measurements are with 50 ohm impedance.

2. See TN1124, [LatticeECP2M SERDES/PCS Usage Guide](#) for actual binary settings.

Table 3-8. Channel Output Jitter - x10 Mode

Description	Frequency	Min.	Typ.	Max.	Units
Deterministic	3.125 Gbps	—	0.08	0.12	UI, p-p
Random	3.125 Gbps	—	0.22	0.38	UI, p-p
Total	3.125 Gbps	—	0.33	0.43	UI, p-p
Deterministic	2.5 Gbps	—	0.08	0.17	UI, p-p
Random	2.5 Gbps	—	0.20	0.25	UI, p-p
Total	2.5 Gbps	—	0.25	0.35	UI, p-p
Deterministic	1.25 Gbps	—	0.03	0.10	UI, p-p
Random	1.25 Gbps	—	0.14	0.19	UI, p-p
Total	1.25 Gbps	—	0.17	0.24	UI, p-p
Deterministic	250 Mbps	—	0.04	0.17	UI, p-p
Random	250 Mbps	—	0.12	0.13	UI, p-p
Total	250 Mbps	—	0.15	0.29	UI, p-p

Note: Values are measured with PRBS 2⁷-1, all channels operating, FPGA Logic active, I/Os around SERDES pins quiet, reference clock at x10 mode.

SERDES High Speed Data Receiver (LatticeECP2M Family Only)

Table 3-11. Serial Input Data Specifications

Symbol	Description	Min.	Typ.	Max.	Units
RX-CID _S	Stream of nontransitions ¹ (CID = Consecutive Identical Digits) @ 10 ⁻¹² BER		7 @ 3.125 Gbps 20 @ 1.25 Gbps		Bits
V _{RX-DIFF-S}	Differential input sensitivity	100	—	—	mV, p-p
V _{RX-IN}	Input levels	0	—	V _{CCR_X} + 0.8	V
V _{RX-CM-DC}	Input common mode range (DC coupled)	0.5	—	1.2	V
V _{RX-CM-AC}	Input common mode range (AC coupled) ³	0	—	1.5	V
T _{RX-RELOCK}	CDR re-lock time ²	—	—	3000	Bits
Z _{RX-TERM}	Input termination 50/75 Ohm/High Z	—	50		Ohms
RL _{RX-RL}	Return loss (without package)	—	9	—	dB

1. This is the number of bits allowed without a transition on the incoming data stream when using DC coupling.
2. This is the typical number of bit times to re-lock to a new phase of frequency within +/- 300 ppm, assuming 8b10b encoded data and the CDR is in lock state. When CDR is in un-lock state, or reset is applied, the total re-lock settling time will be approximately 4ms including analog settle time, calibration time, and acquisition time.
3. AC coupling is used to interface to LVPECL and LVDS.

Input Data Jitter Tolerance

A receiver's ability to tolerate incoming signal jitter is very dependent on jitter type. High speed serial interface standards have recognized the dependency on jitter type and have recently modified specifications to indicate tolerance levels for different jitter types as they relate to specific protocols (e.g. FC, etc.). Sinusoidal jitter is considered to be a worst case jitter type.

Table 3-12. Receiver Total Jitter Tolerance Specification¹

Description	Frequency	Condition	Min.	Typ.	Max.	Units
Deterministic	3.125 Gbps	600 mV differential eye	—	—	0.54	UI, p-p
Random		600 mV differential eye	—	—	0.26	UI, p-p
Total		600 mV differential eye	—	—	0.80	UI, p-p
Deterministic	2.5 Gbps	600 mV differential eye	—	—	0.61	UI, p-p
Random		600 mV differential eye	—	—	0.22	UI, p-p
Total		600 mV differential eye	—	—	0.81	UI, p-p
Deterministic	1.25 Gbps	600 mV differential eye	—	—	0.53	UI, p-p
Random		600 mV differential eye	—	—	0.22	UI, p-p
Total		600 mV differential eye	—	—	0.80	UI, p-p
Deterministic	250 Mbps ²	600 mV differential eye	—	—	0.42	UI, p-p
Random		600 mV differential eye	—	—	0.10	UI, p-p
Total		600 mV differential eye	—	—	0.60	UI, p-p

1. Values are measured with PRBS 2⁷-1, all channels operating, FPGA Logic active, I/Os around SERDES pins quiet, voltages are nominal, room temperature.
2. Jitter specification is limited by measurement equipment capability.

LatticeECP2 Pin Information Summary, LFE2-6 and LFE2-12 (Cont.)

Pin Type		LFE2-6		LFE2-12			
		144 TQFP	256 fpBGA	144 TQFP	208 PQFP	256 fpBGA	484 fpBGA
Available DDR-Interfaces per I/O Bank ¹	Bank0	0	0	0	0	0	0
	Bank1	0	0	0	0	0	0
	Bank2	0	1	0	0	1	1
	Bank3	0	0	0	0	0	0
	Bank4	0	2	0	0	2	3
	Bank5	0	1	0	0	1	3
	Bank6	0	1	0	0	1	1
	Bank7	0	1	0	0	1	1
	Bank8	0	0	0	0	0	0
PCI Capable I/Os per Bank	Bank0	0	0	0	0	0	0
	Bank1	0	0	0	0	0	0
	Bank2	0	0	0	0	0	0
	Bank3	0	0	0	0	0	0
	Bank4	18	32	18	19	32	46
	Bank5	8	14	10	18	17	46
	Bank6	0	0	0	0	0	0
	Bank7	0	0	0	0	0	0
	Bank8	0	0	0	0	0	0

1. Minimum requirement to implement a fully functional 8-bit wide DDR bus. Available DDR interface consists of at least 12 I/Os (1 DQS + 1 DQSB + 8 DQs + 1 DM + Bank VREF1).

LFE2-20E/SE Logic Signal Connections: 256 fpBGA

LFE2-20E/SE					
Ball Number	Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
C3	C3	PL2A	7	VREF2_7	T (LVDS)*
C2	C2	PL2B	7	VREF1_7	C (LVDS)*
VCCIO	VCCIO	VCCIO7	7		
-	GND	GNDIO7	7		
D3	D3	PL7A	7	LDQ8	T
D4	D4	PL6A	7	LDQ8	T (LVDS)*
D2	D2	PL7B	7	LDQ8	C
GND	GND	GNDIO7	-		
E4	E4	PL6B	7	LDQ8	C (LVDS)*
B1	B1	PL13A	7	LDQ16	T
C1	C1	PL13B	7	LDQ16	C
F5	F5	PL15A	7	LDQ16	T
VCCIO	VCC	VCCIO	7		
F4	F4	PL14A	7	LDQ16	T (LVDS)*
G6	G6	PL15B	7	LDQ16	C
G4	G4	PL14B	7	LDQ16	C (LVDS)*
D1	D1	PL16A	7	LDQS16	T (LVDS)*
GND	GND	GNDIO7	-		
E1	E1	PL16B	7	LDQ16	C (LVDS)*
F3	F3	PL17A	7	LDQ16	T
G3	G3	PL17B	7	LDQ16	C
VCCIO	VCCIO	VCCIO7	7		
F2	F2	PL18A	7	LDQ16	T (LVDS)*
F1	F1	PL18B	7	LDQ16	C (LVDS)*
GND	GND	GNDIO7	-		
G2	G2	PL19A	7	PCLKT7_0/LDQ16	T
G1	G1	PL19B	7	PCLKC7_0/LDQ16	C
H6	H6	PL21A	6	PCLKT6_0/LDQ25	T (LVDS)*
VCCIO	VCCIO	VCCIO6	6		
H5	H5	PL21B	6	PCLKC6_0/LDQ25	C (LVDS)*
H4	H4	PL22A	6	VREF2_6/LDQ25	T
GND	GND	GNDIO6	-		
H3	H3	PL22B	6	VREF1_6/LDQ25	C
H2	H2	PL27A	6	LLM0_GDLLT_IN_A**/LDQ25	T (LVDS)*
H1	H1	PL27B	6	LLM0_GDLLC_IN_A**/LDQ25	C (LVDS)*
G10	G10	VCC	-		
J4	J4	PL28A	6	LLM0_GDLLT_FB_A/LDQ25	T
J5	J5	PL28B	6	LLM0_GDLLC_FB_A/LDQ25	C
J6	J6	LLM0_PLLCAP	6		
K4	K4	PL30A	6	LLM0_GPLLT_IN_A**/LDQ34	T (LVDS)*
GND	GND	GNDIO6	-		

LFE2-20E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-20E/SE					
Ball Number	Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
VCCIO	VCCIO	VCCIO1	1		
D12	D12	PT62A	1		T
B14	B14	PT61B	1		C
C14	C14	PT60B	1		C
A14	A14	PT61A	1		T
D13	D13	PT60A	1		T
C13	C13	PT59B	1		C
GND	GND	GNDIO1	-		
A13	A13	PT58B	1		C
B13	B13	PT59A	1		T
VCCIO	VCCIO	VCCIO1	1		
A12	A12	PT58A	1		T
B11	B11	PT57B	1		C
D11	D11	PT56B	1		C
A11	A11	PT57A	1		T
C11	C11	PT56A	1		T
-	GND	GNDIO1	1		
-	VCC	VCCIO	1		
D10	D10	PT46B	1		C
C10	C10	PT46A	1		T
GND	GND	GNDIO1	-		
B10	B10	PT45B	1		C
A9	A9	PT44B	1		C
A10	A10	PT45A	1		T
B9	B9	PT44A	1		T
VCCIO	VCCIO	VCCIO1	1		
A8	A8	PT43B	1		C
D9	D9	PT42B	1		C
B8	B8	PT43A	1		T
C9	C9	PT42A	1		T
GND	GND	GNDIO1	-		
B7	B7	PT41B	1		C
E9	E9	PT40B	1		C
A7	A7	PT41A	1		T
D8	D8	PT40A	1		T
VCCIO	VCCIO	VCCIO1	1		
A6	A6	PT39B	1	PCLKC1_0	C
B6	B6	PT39A	1	PCLKT1_0	T
E6	E6	XRES	1		
F8	F8	PT37B	0	PCLKC0_0	C
GND	GND	GNDIO0	-		
E8	E8	PT37A	0	PCLKT0_0	T

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AA14	PB29B	5	BDQ33	C	PB29B	5	BDQ33	C	
AE10	PB30A	5	BDQ33	T	PB30A	5	BDQ33	T	
AF10	PB30B	5	BDQ33	C	PB30B	5	BDQ33	C	
W14	PB31A	5	BDQ33	T	PB31A	5	BDQ33	T	
AB13	PB31B	5	BDQ33	C	PB31B	5	BDQ33	C	
VCCIO	VCCIO5	5			VCCIO5	5			
Y14	PB32A	5	BDQ33	T	PB32A	5	BDQ33	T	
AB14	PB32B	5	BDQ33	C	PB32B	5	BDQ33	C	
GND	GNDIO5	-			GNDIO5	-			
AE11	PB33A	5	BDQS33	T	PB33A	5	BDQS33	T	
AF11	PB33B	5	BDQ33	C	PB33B	5	BDQ33	C	
AD14	PB34A	5	BDQ33	T	PB34A	5	BDQ33	T	
AA15	PB34B	5	BDQ33	C	PB34B	5	BDQ33	C	
AE12	PB35A	5	PCLKT5_0/BDQ33	T	PB35A	5	PCLKT5_0/BDQ33	T	
AF12	PB35B	5	PCLKC5_0/BDQ33	C	PB35B	5	PCLKC5_0/BDQ33	C	
VCCIO	VCCIO5	5			VCCIO5	5			
GND	GNDIO5	-			GNDIO5	-			
AD15	PB40A	4	PCLKT4_0/BDQ42	T	PB40A	4	PCLKT4_0/BDQ42	T	
VCCIO	VCCIO4	4			VCCIO4	4			
AC15	PB40B	4	PCLKC4_0/BDQ42	C	PB40B	4	PCLKC4_0/BDQ42	C	
AE13	PB41A	4	BDQ42	T	PB41A	4	BDQ42	T	
AF13	PB41B	4	BDQ42	C	PB41B	4	BDQ42	C	
AB17	PB42A	4	BDQS42	T	PB42A	4	BDQS42	T	
GND	GNDIO4	-			GNDIO4	-			
Y15	PB42B	4	BDQ42	C	PB42B	4	BDQ42	C	
AE14	PB43A	4	BDQ42	T	PB43A	4	BDQ42	T	
AF14	PB43B	4	BDQ42	C	PB43B	4	BDQ42	C	
AA16	PB44A	4	BDQ42	T	PB44A	4	BDQ42	T	
VCCIO	VCCIO4	4			VCCIO4	4			
W15	PB44B	4	BDQ42	C	PB44B	4	BDQ42	C	
AC17	PB45A	4	BDQ42	T	PB45A	4	BDQ42	T	
AB16	PB45B	4	BDQ42	C	PB45B	4	BDQ42	C	
AE15	PB46A	4	BDQ42	T	PB46A	4	BDQ42	T	
GND	GNDIO4	-			GNDIO4	-			
AF15	PB46B	4	BDQ42	C	PB46B	4	BDQ42	C	
AE16	PB47A	4	BDQ51	T	PB47A	4	BDQ51	T	
AF16	PB47B	4	BDQ51	C	PB47B	4	BDQ51	C	
Y16	PB48A	4	BDQ51	T	PB48A	4	BDQ51	T	
AB18	PB48B	4	BDQ51	C	PB48B	4	BDQ51	C	
AD17	PB49A	4	BDQ51	T	PB49A	4	BDQ51	T	
AD18	PB49B	4	BDQ51	C	PB49B	4	BDQ51	C	
VCCIO	VCCIO4	4			VCCIO4	4			
AC18	PB50A	4	BDQ51	T	PB50A	4	BDQ51	T	
AD19	PB50B	4	BDQ51	C	PB50B	4	BDQ51	C	
GND	GNDIO4	-			GNDIO4	-			
AC19	PB51A	4	BDQS51	T	PB51A	4	BDQS51	T	

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
L23	VCCIO2	2			VCCIO2	2		
M17	VCCIO2	2			VCCIO2	2		
M18	VCCIO2	2			VCCIO2	2		
AA23	VCCIO3	3			VCCIO3	3		
R17	VCCIO3	3			VCCIO3	3		
R18	VCCIO3	3			VCCIO3	3		
T23	VCCIO3	3			VCCIO3	3		
V20	VCCIO3	3			VCCIO3	3		
AC16	VCCIO4	4			VCCIO4	4		
AC21	VCCIO4	4			VCCIO4	4		
U15	VCCIO4	4			VCCIO4	4		
V15	VCCIO4	4			VCCIO4	4		
Y18	VCCIO4	4			VCCIO4	4		
AC11	VCCIO5	5			VCCIO5	5		
AC6	VCCIO5	5			VCCIO5	5		
U12	VCCIO5	5			VCCIO5	5		
V12	VCCIO5	5			VCCIO5	5		
Y9	VCCIO5	5			VCCIO5	5		
AA4	VCCIO6	6			VCCIO6	6		
R10	VCCIO6	6			VCCIO6	6		
R9	VCCIO6	6			VCCIO6	6		
T4	VCCIO6	6			VCCIO6	6		
V7	VCCIO6	6			VCCIO6	6		
F4	VCCIO7	7			VCCIO7	7		
J7	VCCIO7	7			VCCIO7	7		
L4	VCCIO7	7			VCCIO7	7		
M10	VCCIO7	7			VCCIO7	7		
M9	VCCIO7	7			VCCIO7	7		
AE25	VCCIO8	8			VCCIO8	8		
V18	VCCIO8	8			VCCIO8	8		
J10	VCCAUX	-			VCCAUX	-		
J11	VCCAUX	-			VCCAUX	-		
J16	VCCAUX	-			VCCAUX	-		
J17	VCCAUX	-			VCCAUX	-		
K18	VCCAUX	-			VCCAUX	-		
K9	VCCAUX	-			VCCAUX	-		
L18	VCCAUX	-			VCCAUX	-		
L9	VCCAUX	-			VCCAUX	-		
T18	VCCAUX	-			VCCAUX	-		
T9	VCCAUX	-			VCCAUX	-		
U18	VCCAUX	-			VCCAUX	-		
U9	VCCAUX	-			VCCAUX	-		
V10	VCCAUX	-			VCCAUX	-		
V11	VCCAUX	-			VCCAUX	-		
V16	VCCAUX	-			VCCAUX	-		
V17	VCCAUX	-			VCCAUX	-		

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
E21	PT76A	1		T
VCCIO	VCCIO1	1		
B22	PT75B	1		C
A22	PT75A	1		T
H20	PT74B	1		C
F21	PT74A	1		T
F20	PT73B	1		C
GND	GNDIO1	-		
H19	PT73A	1		T
D21	PT72B	1		C
C21	PT72A	1		T
E20	PT71B	1		C
VCCIO	VCCIO1	1		
G21	PT71A	1		T
B21	PT70B	1		C
A21	PT70A	1		T
F19	PT69B	1		C
G20	PT69A	1		T
E19	PT68B	1		C
GND	GNDIO1	-		
G19	PT68A	1		T
D20	PT67B	1		C
VCCIO	VCCIO1	1		
C20	PT67A	1		T
B20	PT66B	1		C
A20	PT66A	1		T
F18	PT65B	1		C
H18	PT65A	1		T
D19	PT64B	1		C
C19	PT64A	1		T
GND	GNDIO1	-		
G18	PT63B	1		C
E18	PT63A	1		T
H17	PT62B	1		C
F17	PT62A	1		T
VCCIO	VCCIO1	1		
G17	PT61B	1		C
E17	PT61A	1		T
B19	PT60B	1		C
A19	PT60A	1		T
GND	GNDIO1	-		
D17	PT59B	1		C
B18	PT59A	1		T

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
A3	GND	-			GND	-		
A9	GND	-			GND	-		
B12	GND	-			GND	-		
B6	GND	-			GND	-		
E15	GND	-			GND	-		
E2	GND	-			GND	-		
H14	GND	-			GND	-		
H8	GND	-			GND	-		
H9	GND	-			GND	-		
J3	GND	-			GND	-		
J8	GND	-			GND	-		
J9	GND	-			GND	-		
M15	GND	-			GND	-		
M2	GND	-			GND	-		
P9	GND	-			GND	-		
R12	GND	-			GND	-		
R5	GND	-			GND	-		
T1	GND	-			GND	-		
T16	GND	-			GND	-		
D10	NC	-			NC	-		
D11	NC	-			NC	-		
D12	NC	-			NC	-		
D13	NC	-			NC	-		
D14	NC	-			NC	-		
D4	NC	-			NC	-		
D5	NC	-			NC	-		
D6	NC	-			NC	-		
D7	NC	-			NC	-		
E11	NC	-			NC	-		
E6	NC	-			NC	-		
E8	NC	-			NC	-		
E9	NC	-			NC	-		
F10	NC	-			NC	-		
F7	NC	-			NC	-		
F8	NC	-			NC	-		
F9	NC	-			NC	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
L4	PL24B	7	LDQ22	C (LVDS)*	PL34B	7	LDQ32	C (LVDS)*	
M1	PL25A	7	PCLKT7_0/LDQ22	T	PL35A	7	PCLKT7_0/LDQ32	T	
GNDIO	GNDIO7	-			GNDIO7	-			
M2	PL25B	7	PCLKC7_0/LDQ22	C	PL35B	7	PCLKC7_0/LDQ32	C	
M6	PL27A	6	PCLKT6_0	T (LVDS)*	PL37A	6	PCLKT6_0	T (LVDS)*	
M5	PL27B	6	PCLKC6_0	C (LVDS)*	PL37B	6	PCLKC6_0	C (LVDS)*	
M3	PL28A	6	VREF2_6	T	PL38A	6	VREF2_6	T	
M4	PL28B	6	VREF1_6	C	PL38B	6	VREF1_6	C	
VCCIO	VCCIO6	6			VCCIO6	6			
N7	PL31A	6	LLM1_SPLLT_IN_A	T (LVDS)*	PL41A	6	LLM2_SPLLT_IN_A	T (LVDS)*	
GNDIO	GNDIO6	-			GNDIO6	-			
N6	PL31B	6	LLM1_SPLLC_IN_A	C (LVDS)*	PL41B	6	LLM2_SPLLC_IN_A	C (LVDS)*	
N1	PL32A	6	LLM1_SPLLT_FB_A	T	PL42A	6	LLM2_SPLLT_FB_A	T	
N2	PL32B	6	LLM1_SPLLC_FB_A	C	PL42B	6	LLM2_SPLLC_FB_A	C	
VCCIO	VCCIO6	6			VCCIO6	6			
GNDIO	GNDIO6	-			GNDIO6	-			
P6	PL38A	6	LDQS38****	T (LVDS)*	PL48A	6	LDQS48****	T (LVDS)*	
N5	PL38B	6	LDQ38	C (LVDS)*	PL48B	6	LDQ48	C (LVDS)*	
P1	PL39A	6	LDQ38	T	PL49A	6	LDQ48	T	
VCCIO	VCCIO6	6			VCCIO6	6			
P2	PL39B	6	LDQ38	C	PL49B	6	LDQ48	C	
P3	PL40A	6	LDQ38	T (LVDS)*	PL50A	6	LDQ48	T (LVDS)*	
P4	PL40B	6	LDQ38	C (LVDS)*	PL50B	6	LDQ48	C (LVDS)*	
P5	PL41A	6	LDQ38	T	PL51A	6	LDQ48	T	
GNDIO	GNDIO6	-			GNDIO6	-			
P7	PL41B	6	LDQ38	C	PL51B	6	LDQ48	C	
R1	PL42A	6	LLM0_GPLLT_IN_A**	T (LVDS)*	PL57A	6	LLM0_GPLLT_IN_A**/LDQS57****	T (LVDS)*	
GNDIO	GNDIO6	-			GNDIO6	-			
R2	PL42B	6	LLM0_GPLLC_IN_A**	C (LVDS)*	PL57B	6	LLM0_GPLLC_IN_A**/LDQ57	C (LVDS)*	
R3	PL43A	6	LLM0_GPLLT_FB_A	T	PL58A	6	LLM0_GPLLT_FB_A/LDQ57	T	
R4	PL43B	6	LLM0_GPLLC_FB_A	C	PL58B	6	LLM0_GPLLC_FB_A/LDQ57	C	
VCCIO	VCCIO6	6			VCCIO6	6			
R6	PL44A	6	LLM0_GDLT_IN_A**	T (LVDS)*	PL59A	6	LLM0_GDLT_IN_A**/LDQ57	T (LVDS)*	
R5	PL44B	6	LLM0_GDLLC_IN_A**	C (LVDS)*	PL59B	6	LLM0_GDLLC_IN_A**/LDQ57	C (LVDS)*	
T1	PL45A	6	LLM0_GDLT_FB_A	T	PL60A	6	LLM0_GDLT_FB_A/LDQ57	T	
T2	PL45B	6	LLM0_GDLLC_FB_A	C	PL60B	6	LLM0_GDLLC_FB_A/LDQ57	C	
GNDIO	GNDIO6	-			GNDIO6	-			
R7	LLM0_PLLCAP	6			LLM0_PLLCAP	6			
T6	PL47A	6	LDQ51	T (LVDS)*	PL62A	6	LDQ66	T (LVDS)*	
T7	PL47B	6	LDQ51	C (LVDS)*	PL62B	6	LDQ66	C (LVDS)*	
U1	PL48A	6	LDQ51	T	PL63A	6	LDQ66	T	
U2	PL48B	6	LDQ51	C	PL63B	6	LDQ66	C	
VCCIO	VCCIO6	6			VCCIO6	6			
T3	PL49A	6	LDQ51	T (LVDS)*	PL64A	6	LDQ66	T (LVDS)*	
U3	PL49B	6	LDQ51	C (LVDS)*	PL64B	6	LDQ66	C (LVDS)*	
U6	PL50A	6	LDQ51	T	NC	-			
U5	PL50B	6	LDQ51	C	PL65B	6	LDQ66	C	
GNDIO	GNDIO6	-			GNDIO6	-			

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
V5	PL51A	6	LDQS51	T (LVDS)*	PL66A	6	LDQS66	T (LVDS)*	
U4	PL51B	6	LDQ51	C (LVDS)*	PL66B	6	LDQ66	C (LVDS)*	
V1	PL52A	6	LDQ51	T	PL67A	6	LDQ66	T	
VCCIO	VCCIO6	6			VCCIO6	6			
V3	PL52B	6	LDQ51	C	PL67B	6	LDQ66	C	
W1	PL53A	6	LDQ51	T (LVDS)*	PL68A	6	LDQ66	T (LVDS)*	
Y1	PL53B	6	LDQ51	C (LVDS)*	PL68B	6	LDQ66	C (LVDS)*	
AA1	PL54A	6	LDQ51	T	PL69A	6	LDQ66	T	
GNDIO	GNDIO6	-			GNDIO6	-			
AA2	PL54B	6	LDQ51	C	PL69B	6	LDQ66	C	
V4	TCK	-			TCK	-			
Y2	TDI	-			TDI	-			
Y3	TMS	-			TMS	-			
W3	TDO	-			TDO	-			
W4	VCCJ	-			VCCJ	-			
W5	PB2A	5	BDQ6	T	PB2A	5	BDQ6	T	
Y4	PB2B	5	BDQ6	C	PB2B	5	BDQ6	C	
W6	PB3A	5	BDQ6	T	PB3A	5	BDQ6	T	
V6	PB3B	5	BDQ6	C	PB3B	5	BDQ6	C	
AA3	PB4A	5	BDQ6	T	PB4A	5	BDQ6	T	
VCCIO	VCCIO5	5			VCCIO5	5			
AB2	PB4B	5	BDQ6	C	PB4B	5	BDQ6	C	
T8	PB5A	5	BDQ6	T	PB5A	5	BDQ6	T	
U7	PB5B	5	BDQ6	C	PB5B	5	BDQ6	C	
U8	PB6A	5	BDQS6	T	PB6A	5	BDQS6	T	
GNDIO	GNDIO5	-			GNDIO5	-			
T9	PB6B	5	BDQ6	C	PB6B	5	BDQ6	C	
V8	PB7A	5	BDQ6	T	PB7A	5	BDQ6	T	
W8	PB7B	5	BDQ6	C	PB7B	5	BDQ6	C	
Y6	PB8A	5	BDQ6	T	PB8A	5	BDQ6	T	
VCCIO	VCCIO5	5			VCCIO5	5			
Y5	PB8B	5	BDQ6	C	PB8B	5	BDQ6	C	
AB3	PB9A	5	BDQ6	T	PB9A	5	BDQ6	T	
AB4	PB9B	5	BDQ6	C	PB9B	5	BDQ6	C	
AB5	PB10A	5	BDQ6	T	PB10A	5	BDQ6	T	
GNDIO	GNDIO5	-			GNDIO5	-			
AA6	PB10B	5	BDQ6	C	PB10B	5	BDQ6	C	
V9	PB13A	5	BDQ15	T	PB31A	5	BDQ33	T	
U9	PB13B	5	BDQ15	C	PB31B	5	BDQ33	C	
VCCIO	VCCIO5	5			VCCIO5	5			
-	-	-			GNDIO5	-			
U10	PB14A	5	BDQ15	T	PB32A	5	BDQ33	T	
T10	PB14B	5	BDQ15	C	PB32B	5	BDQ33	C	
GNDIO	GNDIO5	-			GNDIO5	-			
W9	PB15A	5	BDQS15****	T	PB33A	5	BDQS33****	T	
Y8	PB15B	5	BDQ15	C	PB33B	5	BDQ33	C	
AA7	PB16A	5	VREF2_5/BDQ15	T	PB34A	5	VREF2_5/BDQ33	T	
Y7	PB16B	5	VREF1_5/BDQ15	C	PB34B	5	VREF1_5/BDQ33	C	

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AH25	LRC_SQ_VCCOB1	13			LRC_SQ_VCCOB1	13			
AJ25	LRC_SQ_HDOUTN1	13		C	LRC_SQ_HDOUTN1	13		C	
AH26	LRC_SQ_VCCTX1	13			LRC_SQ_VCCTX1	13			
AJ26	LRC_SQ_HDOUTN0	13		C	LRC_SQ_HDOUTN0	13		C	
AK27	LRC_SQ_VCCOB0	13			LRC_SQ_VCCOB0	13			
AK26	LRC_SQ_HDOUTP0	13		T	LRC_SQ_HDOUTP0	13		T	
AH27	LRC_SQ_VCCTX0	13			LRC_SQ_VCCTX0	13			
AJ29	LRC_SQ_HDINN0	13		C	LRC_SQ_HDINN0	13		C	
AJ30	LRC_SQ_VCCIB0	13			LRC_SQ_VCCIB0	13			
AK29	LRC_SQ_HDINP0	13		T	LRC_SQ_HDINP0	13		T	
AH30	LRC_SQ_VCCRX0	13			LRC_SQ_VCCRX0	13			
AG27	CFG2	8			CFG2	8			
AD25	CFG1	8			CFG1	8			
AG28	CFG0	8			CFG0	8			
AG30	PROGRAMN	8			PROGRAMN	8			
AG29	CCLK	8			CCLK	8			
AC24	INITN	8			INITN	8			
AF27	DONE	8			DONE	8			
GNDIO	GNDIO8	-			GNDIO8	-			
AF28	WRITEN***	8			WRITEN***	8			
AE26	CS1N***	8			CS1N***	8			
AB23	CSN***	8			CSN***	8			
AF29	D0/SPIFASTN***	8			D0/SPIFASTN***	8			
VCCIO	VCCIO8	8			VCCIO8	8			
AF30	D1***	8			D1***	8			
AD26	D2***	8			D2***	8			
AE29	D3***	8			D3***	8			
GNDIO	GNDIO8	-			GNDIO8	-			
AE30	D4***	8			D4***	8			
AD29	D5***	8			D5***	8			
AC25	D6***	8			D6***	8			
AD30	D7/SPID0***	8			D7/SPID0***	8			
VCCIO	VCCIO8	8			VCCIO8	8			
AA22	DI/CSSPI0N***	8			DI/CSSPI0N***	8			
AC26	DOUT/CSON/ CSSPI1N***	8			DOUT/CSON/ CSSPI1N***	8			
AA23	BUSY/SISPI***	8			BUSY/SISPI***	8			
AB22	RLM0_PLLCAP	3			RLM0_PLLCAP	3			
AC27	PR65B	3	RLM0_GDLLC_FB_A	C	PR85B	3	RLM0_GDLLC_FB_A/RDQ82	C	
GNDIO	GNDIO3	-			GNDIO3	-			
AC28	PR65A	3	RLM0_GDLLT_FB_A	T	PR85A	3	RLM0_GDLLT_FB_A/RDQ82	T	
AC29	PR64B	3	RLM0_GDLLC_IN_A**	C (LVDS)*	PR84B	3	RLM0_GDLLC_IN_A**/RDQ82	C (LVDS)*	
AC30	PR64A	3	RLM0_GDLLT_IN_A**	T (LVDS)*	PR84A	3	RLM0_GDLLT_IN_A**/RDQ82	T (LVDS)*	
AB30	PR63B	3	RLM0_GPLL_C_IN_A**	C	PR83B	3	RLM0_GPLL_C_IN_A**/RDQ82	C	
VCCIO	VCCIO3	3			VCCIO3	3			
AA30	PR63A	3	RLM0_GPLLT_IN_A**	T	PR83A	3	RLM0_GPLLT_IN_A**/RDQ82	T	
AB29	PR62B	3	RLM0_GPLL_C_FB_A	C (LVDS)*	PR82B	3	RLM0_GPLL_C_FB_A/RDQ82	C (LVDS)*	
AB28	PR62A	3	RLM0_GPLLT_FB_A	T (LVDS)*	PR82A	3	RLM0_GPLLT_FB_A/RDQ82	T (LVDS)*	
GNDIO	GNDIO3	-			GNDIO3	-			

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
D19	PT93B	1		C
E18	PT93A	1		T
D18	PT92B	1		C
C17	PT92A	1		T
A17	PT91B	1		C
B17	PT91A	1		T
GNDIO	GNDIO1	-		
VCCIO	VCCIO1	1		
J18	PT75B	1		C
J19	PT75A	1		T
H17	PT74B	1		C
J17	PT74A	1		T
F18	PT73B	1		C
F17	PT73A	1		T
GNDIO	GNDIO1	-		
A16	PT72B	1		C
B16	PT72A	1		T
G17	PT71B	1		C
G16	PT71A	1		T
VCCIO	VCCIO1	1		
H16	PT70B	1		C
F16	PT70A	1		T
J16	PT69B	1		C
G15	PT69A	1		T
GNDIO	GNDIO1	-		
C16	PT68B	1		C
D16	PT68A	1		T
J15	PT67B	1		C
H15	PT67A	1		T
VCCIO	VCCIO1	1		
A15	PT66B	1	VREF2_1	C
B15	PT66A	1	VREF1_1	T
F15	PT65B	1	PCLKC1_0	C
E16	PT65A	1	PCLKT1_0	T
C15	PT64B	0	PCLKC0_0	C
GNDIO	GNDIO0	-		
D15	PT64A	0	PCLKT0_0	T
C14	PT63B	0	VREF2_0	C
E15	PT63A	0	VREF1_0	T
G14	PT62B	0		C
VCCIO	VCCIO0	0		
J14	PT62A	0		T
F14	PT61B	0		C

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
K19	VCCIO1	1		
F28	VCCIO2	2		
J25	VCCIO2	2		
K28	VCCIO2	2		
M21	VCCIO2	2		
M24	VCCIO2	2		
N21	VCCIO2	2		
N28	VCCIO2	2		
P21	VCCIO2	2		
R25	VCCIO2	2		
AA28	VCCIO3	3		
AB25	VCCIO3	3		
AE28	VCCIO3	3		
T25	VCCIO3	3		
U21	VCCIO3	3		
V21	VCCIO3	3		
V28	VCCIO3	3		
W21	VCCIO3	3		
W24	VCCIO3	3		
AA18	VCCIO4	4		
AA19	VCCIO4	4		
AE19	VCCIO4	4		
AF22	VCCIO4	4		
AG17	VCCIO4	4		
AG25	VCCIO4	4		
AA12	VCCIO5	5		
AA13	VCCIO5	5		
AE12	VCCIO5	5		
AF9	VCCIO5	5		
AG14	VCCIO5	5		
AG6	VCCIO5	5		
AA3	VCCIO6	6		
AB6	VCCIO6	6		
AE3	VCCIO6	6		
T6	VCCIO6	6		
U10	VCCIO6	6		
V10	VCCIO6	6		
V3	VCCIO6	6		
W10	VCCIO6	6		
W7	VCCIO6	6		
F3	VCCIO7	7		
J6	VCCIO7	7		
K3	VCCIO7	7		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
U8	PL43B	7	LUM3_SPLLC_FB_A/LDQ46	C	PL51B	7	LUM3_SPLLC_FB_A/LDQ54	C
VCCIO	VCCIO7	7			VCCIO7	7		
T6	PL44A	7	LDQ46	T (LVDS)*	PL52A	7	LDQ54	T (LVDS)*
R6	PL44B	7	LDQ46	C (LVDS)*	PL52B	7	LDQ54	C (LVDS)*
U9	PL45A	7	LDQ46	T	PL53A	7	LDQ54	T
T7	PL45B	7	LDQ46	C	PL53B	7	LDQ54	C
GNDIO	GNDIO7	-			GNDIO7	-		
U5	PL46A	7	LDQS46	T (LVDS)*	PL54A	7	LDQS54	T (LVDS)*
U6	PL46B	7	LDQ46	C (LVDS)*	PL54B	7	LDQ54	C (LVDS)*
U7	PL47A	7	LDQ46	T	PL55A	7	LDQ54	T
VCCIO	VCCIO7	7			VCCIO7	7		
V9	PL47B	7	LDQ46	C	PL55B	7	LDQ54	C
V11	PL48A	7	LDQ46	T (LVDS)*	PL56A	7	LDQ54	T (LVDS)*
V10	PL48B	7	LDQ46	C (LVDS)*	PL56B	7	LDQ54	C (LVDS)*
U4	PL49A	7	PCLKT7_0/LDQ46	T	PL57A	7	PCLKT7_0/LDQ54	T
GNDIO	GNDIO7	-			GNDIO7	-		
U3	PL49B	7	PCLKC7_0/LDQ46	C	PL57B	7	PCLKC7_0/LDQ54	C
U2	PL51A	6	PCLKT6_0/LDQ55	T (LVDS)*	PL59A	6	PCLKT6_0/LDQ63	T (LVDS)*
U1	PL51B	6	PCLKC6_0/LDQ55	C (LVDS)*	PL59B	6	PCLKC6_0/LDQ63	C (LVDS)*
V5	PL52A	6	VREF2_6/LDQ55	T	PL60A	6	VREF2_6/LDQ63	T
V6	PL52B	6	VREF1_6/LDQ55	C	PL60B	6	VREF1_6/LDQ63	C
V7	PL53A	6	LDQ55	T (LVDS)*	PL61A	6	LDQ63	T (LVDS)*
VCCIO	VCCIO6	6			VCCIO6	6		
V8	PL53B	6	LDQ55	C (LVDS)*	PL61B	6	LDQ63	C (LVDS)*
V4	PL54A	6	LDQ55	T	PL62A	6	LDQ63	T
V3	PL54B	6	LDQ55	C	PL62B	6	LDQ63	C
V2	PL55A	6	LDQS55	T (LVDS)*	PL63A	6	LDQS63	T (LVDS)*
GNDIO	GNDIO6	-			GNDIO6	-		
V1	PL55B	6	LDQ55	C (LVDS)*	PL63B	6	LDQ63	C (LVDS)*
W7	PL56A	6	LDQ55	T	PL64A	6	LDQ63	T
W5	PL56B	6	LDQ55	C	PL64B	6	LDQ63	C
VCCIO	VCCIO6	6			VCCIO6	6		
W2	PL57A	6	LLM3_SPLLT_IN_A/LDQ55	T (LVDS)*	PL65A	6	LLM4_SPLLT_IN_A/LDQ63	T (LVDS)*
W1	PL57B	6	LLM3_SPLLC_IN_A/LDQ55	C (LVDS)*	PL65B	6	LLM4_SPLLC_IN_A/LDQ63	C (LVDS)*
Y6	PL58A	6	LLM3_SPLLT_FB_A/LDQ55	T	PL66A	6	LLM4_SPLLT_FB_A/LDQ63	T
W6	PL58B	6	LLM3_SPLLC_FB_A/LDQ55	C	PL66B	6	LLM4_SPLLC_FB_A/LDQ63	C
GNDIO	GNDIO6	-			GNDIO6	-		
Y1	PL60A	6	LDQ64	T (LVDS)*	PL68A	6	LDQ72	T (LVDS)*
Y2	PL60B	6	LDQ64	C (LVDS)*	PL68B	6	LDQ72	C (LVDS)*
Y7	PL61A	6	LDQ64	T	PL69A	6	LDQ72	T
Y5	PL61B	6	LDQ64	C	PL69B	6	LDQ72	C
VCCIO	VCCIO6	6			VCCIO6	6		
W10	PL62A	6	LDQ64	T (LVDS)*	PL70A	6	LDQ72	T (LVDS)*
Y8	PL62B	6	LDQ64	C (LVDS)*	PL70B	6	LDQ72	C (LVDS)*
Y4	PL63A	6	LDQ64	T	PL71A	6	LDQ72	T
Y3	PL63B	6	LDQ64	C	PL71B	6	LDQ72	C
GNDIO	GNDIO6	-			GNDIO6	-		
AA1	PL64A	6	LDQS64	T (LVDS)*	PL72A	6	LDQS72	T (LVDS)*
AA2	PL64B	6	LDQ64	C (LVDS)*	PL72B	6	LDQ72	C (LVDS)*

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AA8	PL65A	6	LDQ64	T	PL73A	6	LDQ72	T
VCCIO	VCCIO6	6			VCCIO6	6		
Y9	PL65B	6	LDQ64	C	PL73B	6	LDQ72	C
AA6	PL66A	6	LDQ64	T (LVDS)*	PL74A	6	LDQ72	T (LVDS)*
AA7	PL66B	6	LDQ64	C (LVDS)*	PL74B	6	LDQ72	C (LVDS)*
AA4	PL67A	6	LDQ64	T	PL75A	6	LDQ72	T
GNDIO	GNDIO6	-			GNDIO6	-		
AA3	PL67B	6	LDQ64	C	PL75B	6	LDQ72	C
AA9	PL69A	6	LDQ73	T (LVDS)*	PL77A	6	LDQ81	T (LVDS)*
AA10	PL69B	6	LDQ73	C (LVDS)*	PL77B	6	LDQ81	C (LVDS)*
AA5	PL70A	6	LDQ73	T	PL78A	6	LDQ81	T
AB6	PL70B	6	LDQ73	C	PL78B	6	LDQ81	C
AB1	PL71A	6	LDQ73	T (LVDS)*	PL79A	6	LDQ81	T (LVDS)*
VCCIO	VCCIO6	6			VCCIO6	6		
AB2	PL71B	6	LDQ73	C (LVDS)*	PL79B	6	LDQ81	C (LVDS)*
AC8	PL72A	6	LDQ73	T	PL80A	6	LDQ81	T
AB10	PL72B	6	LDQ73	C	PL80B	6	LDQ81	C
AC1	PL73A	6	LDQS73	T (LVDS)*	PL81A	6	LDQS81	T (LVDS)*
GNDIO	GNDIO6	-			GNDIO6	-		
AC2	PL73B	6	LDQ73	C (LVDS)*	PL81B	6	LDQ81	C (LVDS)*
AB7	PL74A	6	LDQ73	T	PL82A	6	LDQ81	T
AB5	PL74B	6	LDQ73	C	PL82B	6	LDQ81	C
VCCIO	VCCIO6	6			VCCIO6	6		
AC3	PL75A	6	LDQ73	T (LVDS)*	PL83A	6	LDQ81	T (LVDS)*
AC4	PL75B	6	LDQ73	C (LVDS)*	PL83B	6	LDQ81	C (LVDS)*
AC10	PL76A	6	LDQ73	T	PL84A	6	LDQ81	T
AC9	PL76B	6	LDQ73	C	PL84B	6	LDQ81	C
GNDIO	GNDIO6	-			GNDIO6	-		
AC7	NC	-			PL86A	6	LDQ90	T (LVDS)*
AC5	NC	-			PL86B	6	LDQ90	C (LVDS)*
AC6	NC	-			PL87A	6	LDQ90	T
AD5	NC	-			PL87B	6	LDQ90	C
-	-	-			VCCIO6	6		
AD4	NC	-			PL88A	6	LDQ90	T (LVDS)*
AD3	NC	-			PL88B	6	LDQ90	C (LVDS)*
AD10	NC	-			PL89A	6	LDQ90	T
AD8	NC	-			PL89B	6	LDQ90	C
-	-	-			GNDIO6	-		
AD2	NC	-			PL90A	6	LDQS90	T (LVDS)*
AD1	NC	-			PL90B	6	LDQ90	C (LVDS)*
AD9	NC	-			PL91A	6	LDQ90	T
-	-	-			VCCIO6	6		
AC11	NC	-			PL91B	6	LDQ90	C
AD6	NC	-			PL92A	6	LDQ90	T (LVDS)*
AD7	NC	-			PL92B	6	LDQ90	C (LVDS)*
AE1	NC	-			PL93A	6	LDQ90	T
-	-	-			GNDIO6	-		
AE2	NC	-			PL93B	6	LDQ90	C
AF2	PL78A	6	LDQ82	T (LVDS)*	PL95A	6	LDQ99	T (LVDS)*



LatticeECP2/M Family Data Sheet Supplemental Information

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For Further Information

A variety of technical notes for the LatticeECP2/M family are available on the Lattice web site at www.latticesemi.com.

- TN1102, [LatticeECP2/M sysIO Usage Guide](#)
- TN1103, [LatticeECP2/M sysCLOCK PLL Design and Usage Guide](#)
- TN1104, [LatticeECP2/M Memory Usage Guide](#)
- TN1105, [LatticeECP2/M High-Speed I/O Interface](#)
- TN1106, [Power Estimation and Management for LatticeECP2/M Devices](#)
- TN1107, [LatticeECP2/M sysDSP Usage Guide](#)
- TN1108, [LatticeECP2/M sysCONFIG Usage Guide](#)
- TN1109, [LatticeECP2/M Configuration Encryption Usage Guide](#)
- TN1113, [LatticeECP2/M Soft Error Detection \(SED\) Usage Guide](#)
- TN1124, [LatticeECP2M SERDES/PCS Usage Guide](#)
- TN1162, [LatticeECP2/M Hardware Checklist](#)

For further information about interface standards refer to the following web sites:

- JEDEC Standards (LVTTTL, LVCMOS, SSTL, HSTL): www.jedec.org
- PCI: www.pcisig.com